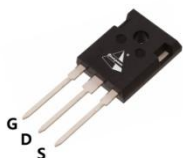


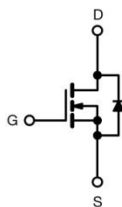


N-channel Power MOSFET

PRODUCT SUMMARY	
V_{DS} (V) at T_J max.	500
$R_{DS(on)}$ max. at 25°C (Ω)	$V_{GS}=10V$ 0.2
Q_g max. (nC)	160
Q_{gs} (nC)	30
Q_{gd} (nC)	53
Configuration	single



TO-247



Schematic diagram

Features

- $I_D=24A(V_{GS}=10V)$
- Ultra Low Gate Charge
- Improved dv/dt Capability
- 100% Avalanche Tested
- $R_{\theta HS}$ compliant

Applications

- Switching Mode Power Supplies (SMPS)
- PWM Motor Controls
- DC to DC Converters
- LED Lighting
- Bridge Circuits

ORDERING INFORMATION	
Device	SPA24N50G
Device Package	TO-247
Marking	24N50G

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ C$, unless otherwise noted)			
Parameter	Symbol	Limit	Unit
		SPA24N50G	
Drain to Source Voltage	V_{DSS}	500	V
Continuous Drain Current (@ $T_C=25^\circ C$)	I_D	24 ⁽¹⁾	A
Continuous Drain Current (@ $T_C=100^\circ C$)		15 ⁽¹⁾	A
Drain current pulsed ⁽²⁾	I_{DM}	96 ⁽¹⁾	A
Gate to Source Voltage	V_{GS}	± 30	V
Single pulsed Avalanche Energy ⁽³⁾	E_{AS}	2016	mJ
Peak diode Recovery dv/dt ⁽⁴⁾	dv/dt	6	V/ns
Total power dissipation (@ $T_C=25^\circ C$)	P_D	280	W
Derating Factor above 25°C		2.2	W/°C
Operating Junction Temperature & Storage Temperature	T_{STG}, T_J	-55 to + 150	°C
Maximum lead temperature for soldering purpose	T_L	260	°C

Notes

1. Drain current is limited by maximum junction temperature.
2. Repetitive rating : pulse width limited by junction temperature.
3. $L = 7mH, I_{AS} = 24A, V_{DD} = 50V, R_G=25\Omega$, Starting at $T_J = 25^\circ C$
4. $I_{SD} \leq I_D, di/dt = 100A/us, V_{DD} \leq BV_{DSS}$, Starting at $T_J = 25^\circ C$



THERMAL CHARACTERISTICS			
Parameter	Symbol	Value	Unit
Thermal resistance, Junction to case	R_{thjc}	0.44	°C/W
Thermal resistance, Junction to ambient	R_{thja}	38	°C/W

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise specified)						
Parameter	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain to source breakdown voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	500	--	--	V
Breakdown voltage temperature coefficient	$\Delta BV_{DSS} / \Delta T_J$	$I_D=250\mu A$, referenced to 25°C	--	0.49	--	V/°C
Drain to source leakage current	I_{DSS}	$V_{DS}=500V, V_{GS}=0V$	--	--	1	μA
		$V_{DS}=500V, T_C=125^\circ\text{C}$	--	--	50	μA
Gate to source leakage current, forward	I_{GSS}	$V_{GS}=30V, V_{DS}=0V$	--	--	100	nA
Gate to source leakage current, reverse		$V_{GS}=-30V, V_{DS}=0V$	--	--	-100	nA
On Characteristics						
Gate threshold voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	--	4	V
Drain to source on state resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=12A$	--	0.15	0.2	Ω
Forward Transconductance	G_{fs}	$V_{DS}=30V, I_D=12A$	--	22	--	S
Dynamic Characteristics						
Input capacitance	C_{iss}	$V_{GS}=0V, V_{DS}=25V, f=1\text{MHz}$	--	5240	--	pF
Output capacitance	C_{oss}		--	472	--	
Reverse transfer capacitance	C_{riss}		--	15	--	
Turn on delay time	$t_{d(on)}$	$V_{DS}=250V, I_D=24A, R_G=25\Omega$	--	76	--	ns
Rising time	t_r		--	82	--	
Turn off delay time	$t_{d(off)}$		--	198	--	
Fall time	t_f		--	78	--	
Total gate charge	Q_g	$V_{DS}=400V, V_{GS}=10V, I_D=24A$	--	118	160	nC
Gate-source charge	Q_{gs}		--	30	--	
Gate-drain charge	Q_{gd}		--	53	--	

SOURCE TO DRAIN DIODE RATINGS CHARACTERISTICS						
Parameter	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous source current	I_S	Integral reverse p-n Junction diode in the MOSFET	--	--	24	A
Pulsed source current	I_{SM}		--	--	96	A
Diode forward voltage drop.	V_{SD}	$I_S=24A, V_{GS}=0V$	--	--	1.4	V
Reverse recovery time	T_{rr}	$I_S=24A, V_{GS}=0V, di/dt=100A/\mu s$	--	520	--	ns
Reverse recovery Charge	Q_{rr}		--	10	--	μC



Fig1. Output characteristics

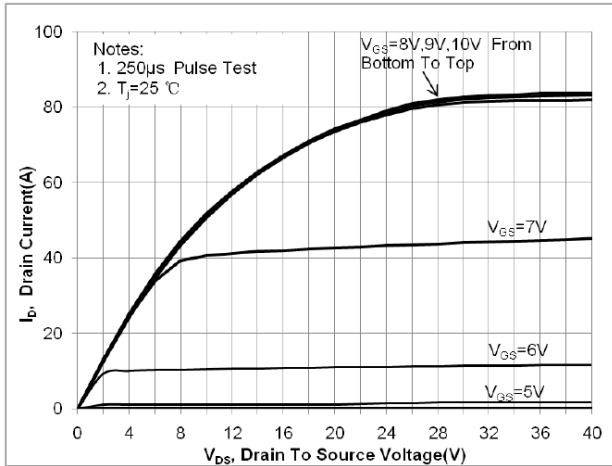


Fig2. Drain-source on-state resistance

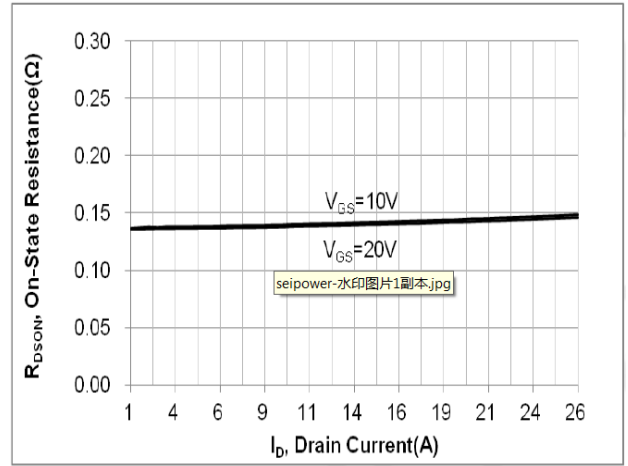


Fig3. Gate charge characteristics

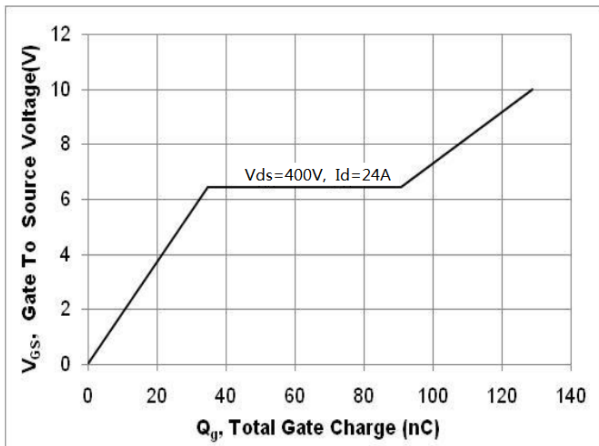


Fig 4. Capacitance Characteristics

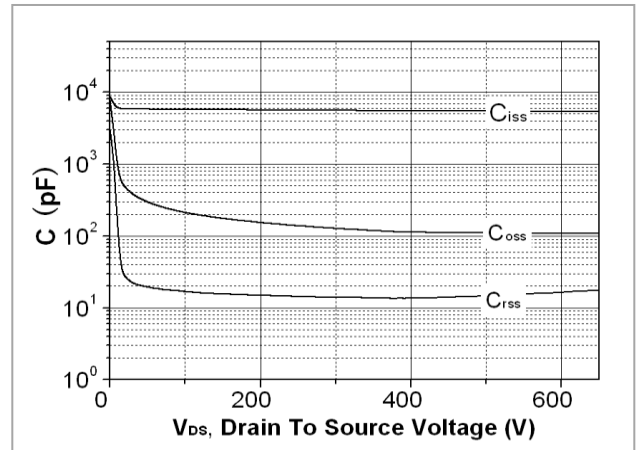


Fig 5. R_{DS(ON)} vs junction temperature

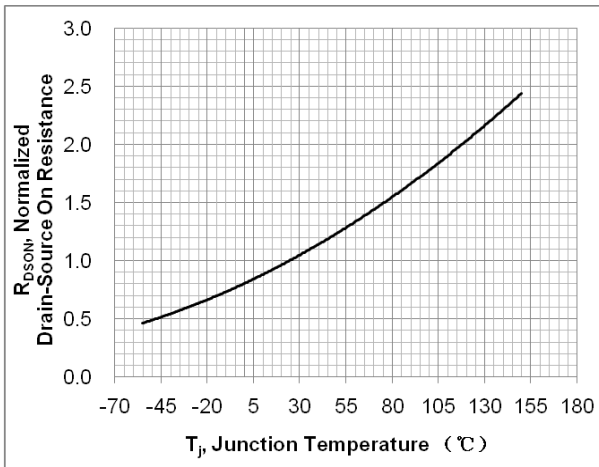


Fig 6. BV_{DSS} vs junction temperature

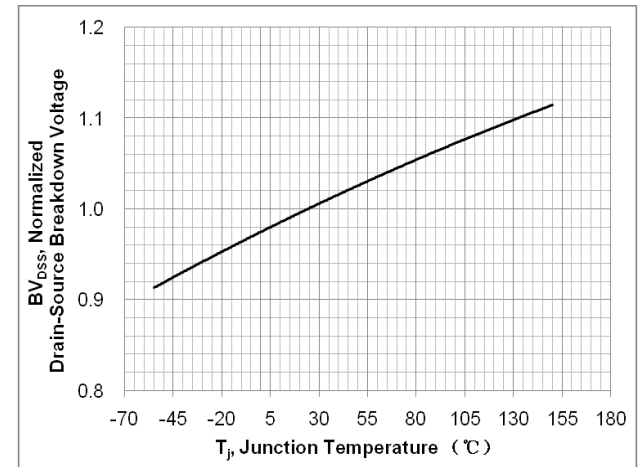


Fig 7 . Safe operating area

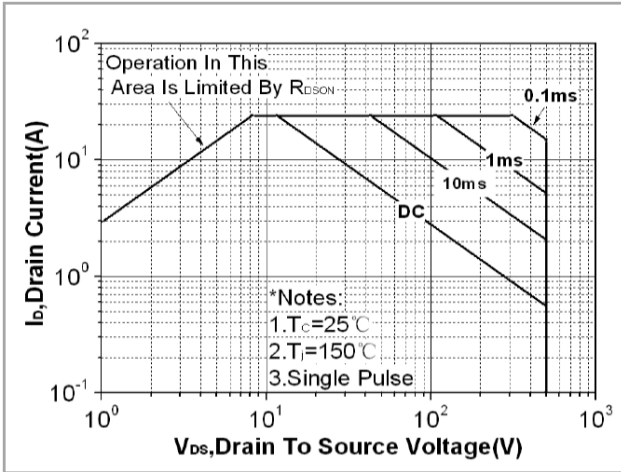


Fig 8 . Transient thermal impedance

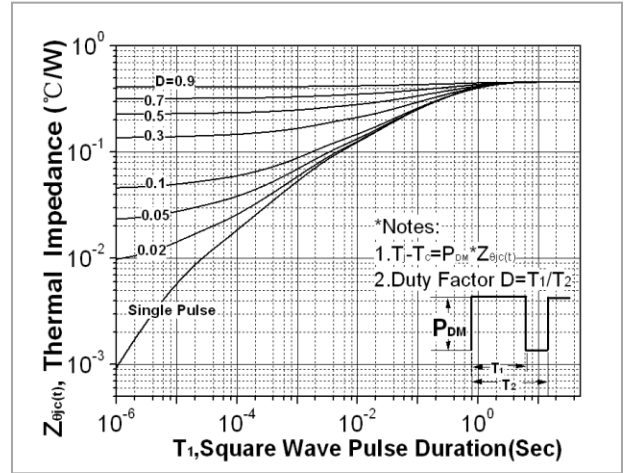


Fig 9. Forward characteristics of reverse diode

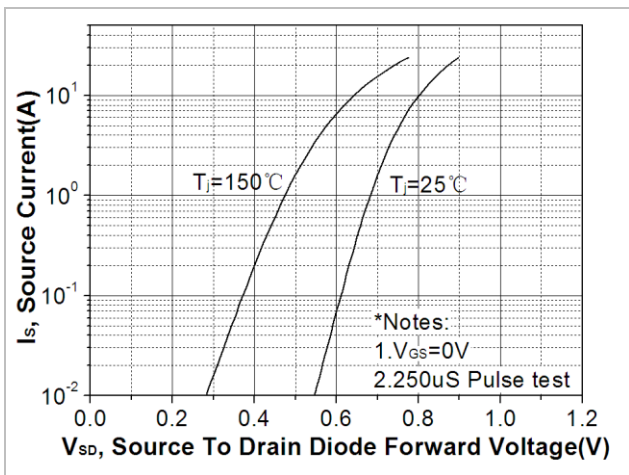


Fig 10. Gate charge test circuit & waveform

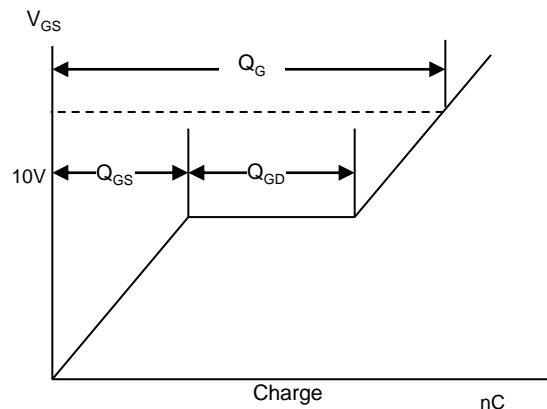
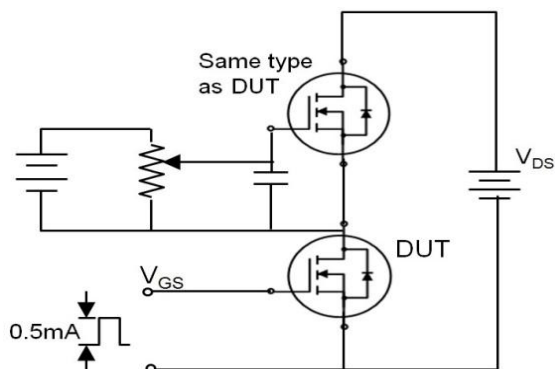


Fig 11. Switching time test circuit & waveform

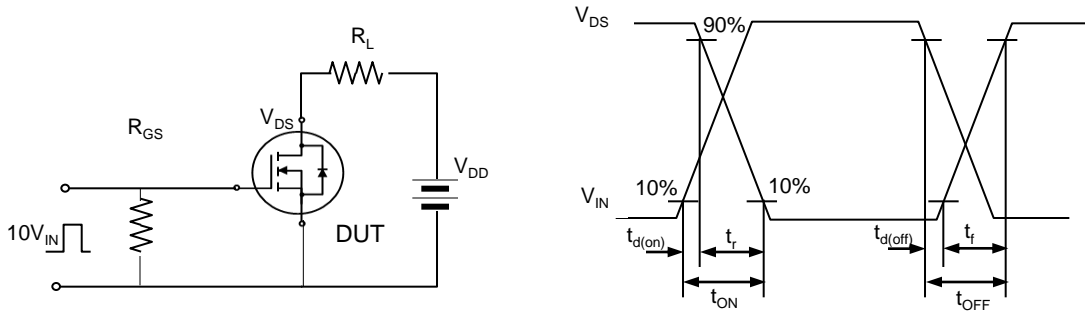


Fig 12. Unclamped Inductive switching test circuit & waveform

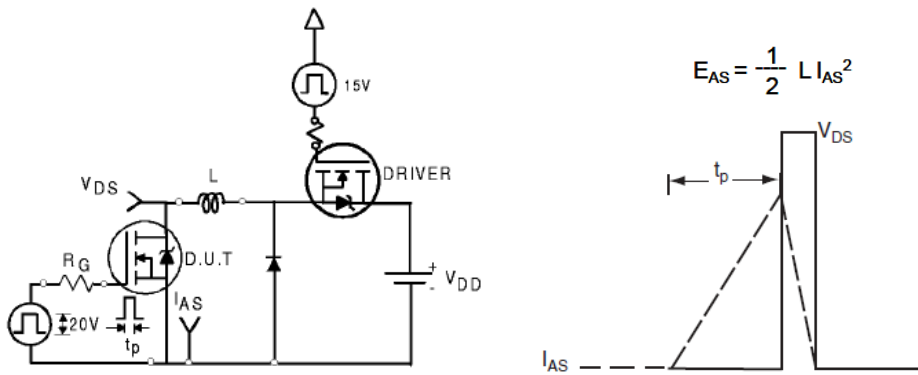
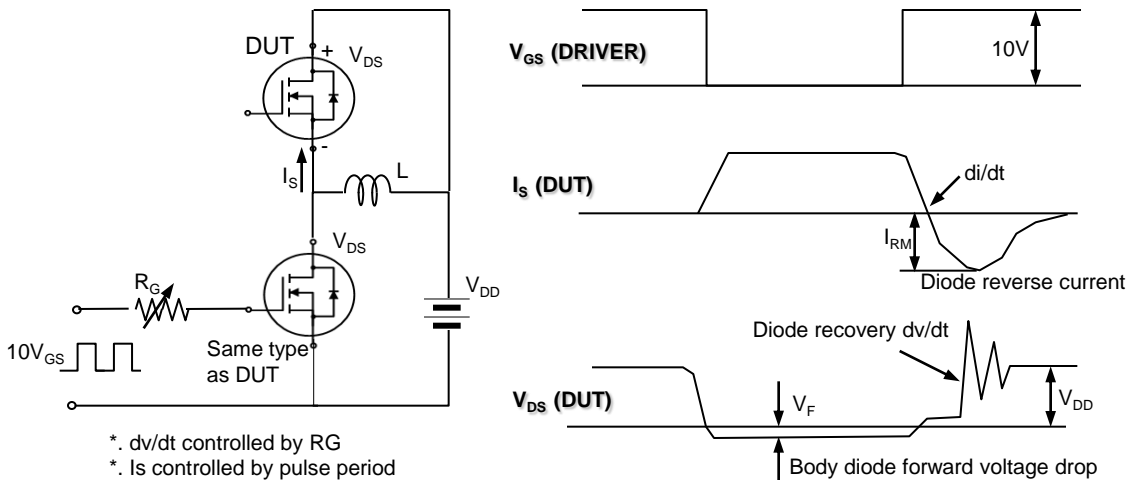


Fig 13. Peak diode recovery dv/dt test circuit & waveform





Disclaimer

- ◆ SINAI assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all SINAI products described or contained herein.
- ◆ Specifications of any and all SINAI products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- ◆ In the event that any or all SINAI products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- ◆ This catalog provides information as of June. 2017. Specifications and information herein are subject to change without notice.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [MOSFET](#) category:

Click to view products by [Sinai Power](#) manufacturer:

Other Similar products are found below :

[614233C](#) [648584F](#) [MCH3443-TL-E](#) [MCH6422-TL-E](#) [FDPF9N50NZ](#) [FW216A-TL-2W](#) [FW231A-TL-E](#) [APT5010JVR](#) [NTNS3A92PZT5G](#)
[IRF100S201](#) [JANTX2N5237](#) [2SK2464-TL-E](#) [2SK3818-DL-E](#) [FCA20N60_F109](#) [FDZ595PZ](#) [STD6600NT4G](#) [FSS804-TL-E](#) [2SJ277-DL-E](#)
[2SK1691-DL-E](#) [2SK2545\(Q,T\)](#) [D2294UK](#) [405094E](#) [423220D](#) [MCH6646-TL-E](#) [TPCC8103,L1Q\(CM](#) [367-8430-0972-503](#) [VN1206L](#)
[424134F](#) [026935X](#) [051075F](#) [SBVS138LT1G](#) [614234A](#) [715780A](#) [NTNS3166NZT5G](#) [751625C](#) [873612G](#) [IRF7380TRHR](#)
[IPS70R2K0CEAKMA1](#) [RJK60S3DPP-E0#T2](#) [RJK60S5DPK-M0#T0](#) [APT5010JVFR](#) [APT12031JFLL](#) [APT12040JVR](#) [DMN3404LQ-7](#)
[NTE6400](#) [JANTX2N6796U](#) [JANTX2N6784U](#) [JANTXV2N5416U4](#) [SQM110N05-06L-GE3](#) [SIHF35N60E-GE3](#)